

**La Causa Beca/Scholarship  
Application Form  
2020-21**

**DESCRIPTION**

La Causa Scholarship's primary goal is to financially assist Mexicano/a, Chicano/a, Latinxs students to obtain a college degree. It was created to encourage students de "los de abajo" to pursue higher education. Scholarships are available on a competitive basis for graduating high school seniors and community college students.

"Una mano no se lava sola, venceremos." Rodolfo Acuña

Award amounts generally range from \$200 to \$400.

**QUALIFICATIONS**

- Be a human being.
- Motivated- *con muchas ganas* to make a difference in our mundo/world
- Spanish bilingual/biliterate
- Demonstrate financial need
- Enrolled in at least six units the following academic term
- Graduating High School Seniors
- Community College Students
- Have a minimum cumulative grade point average (GPA) of 2.0 on a 4.0 scale (or the equivalent)
- Have plans to enroll FULL-TIME in a degree-seeking program at a two or four year U.S. accredited institution in the U.S., Puerto Rico, U.S. Virgin Islands or Guam during the 2021-2022 academic year.
- Be pursuing first undergraduate or graduate degree

**FOR YOUR APPLICATION:**

1. Submit a résumé
2. Submit a personal statement. Minimum two pages, doubled spaced. Provide information on your: background, early & future struggles, negative & positive affiliations, goals and objectives, financial necessity.
3. Answer one of the following questions (in at least 2 pages, typed & double spaced):

*What is the biggest challenge facing Latinx/Mexicanxs/Chicanxs today?*

*What does it mean to be a Chicanx?*

*What is the true meaning of the UFW flag?*

*Cuál es tú causa?*

4. Provide proof of college or university enrollment/schedule.

Questions:

- Questions please contact Martín Ramírez (916) 812-4331
- Return completed app. to: mramirez@live.com

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<b>Full Name</b>	<b>Phone/Email</b>
<b>Street Address</b>	<b>Current Employer</b>
<b>City, State, Zip Code</b>	<b>Cumulative GPA</b>
<b>Intended Major/Area of Study</b>	<b>Application Period</b>
	Application Deadline: May 5 <sup>th</sup> Selection, Award Notifications: May 2021 Verification of Enrollment: Fall 2021 Award Distribution: Fall 2021

By signing this document, I hereby certify that all information provided is accurate and complete to the best of my knowledge.

\_\_\_\_\_  
Applicant Signature

\_\_\_\_\_  
Date

*All information shared on this application will be kept confidential and private.*